PZT2907AT1, SPZT2907AT1G

Preferred Device

PNP Silicon Epitaxial Transistor

This PNP Silicon Epitaxial transistor is designed for use in linear and switching applications. The device is housed in the SOT-223 package which is designed for medium power surface mount applications.

Features

- NPN Complement is PZT2222AT1
- The SOT-223 package can be soldered using wave or reflow
- SOT-223 package ensures level mounting, resulting in improved thermal conduction, and allows visual inspection of soldered joints.
 The formed leads absorb thermal stress during soldering eliminating the possibility of damage to the die.
- AEC-Q101 Qualified and PPAP Capable
- S Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements
- Pb-Free Packages are Available*

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector - Emitter Voltage	V _{CEO}	-60	Vdc
Collector - Base Voltage	V _{CBO}	-60	Vdc
Emitter - Base Voltage	V _{EBO}	-5.0	Vdc
Collector Current - Continuous	I _C	-600	mAdc

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation (Note 1) T _A = 25°C	P _D	1.5 12	W mW/°C
Thermal Resistance Junction-to-Ambient (Note 1)	$R_{\theta JA}$	83.3	°C/W
Lead Temperature for Soldering, 0.0625" from case Time in Solder Bath	TL	260 10	°C Sec
Operating and Storage Temperature Range	T _J , T _{stg}	-65 to +150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. FR-4 with 1 oz and 713 mm² of copper area.

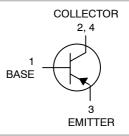


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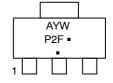
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SOT-223 CASE 318E STYLE 1



MARKING DIAGRAM



P2F = Specific Device Code A = Assembly Location

Y = Year W = Work Week • = Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping [†]
PZT2907AT1	SOT-223	1,000 / Tape & Reel
PZT2907AT1G	SOT-223 (Pb-Free)	1,000 / Tape & Reel
SPZT2907AT1G	SOT-223 (Pb-Free)	1,000 / Tape & Reel
PZT2907AT3	SOT-223	4,000 / Tape & Reel
PZT2907AT3G	SOT-223 (Pb-Free)	4,000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

Preferred devices are recommended choices for future use and best overall value.

^{*}For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

C	Symbol	Min	Тур	Max	Unit	
OFF CHARACTERISTICS	;				I	II.
Collector–Base Breakdown Vo (I _C = -10 μAdc, I _E = 0)	V _{(BR)CBO}	-60	_	-	Vdc	
Collector-Emitter Breakdown (I _C = 10 mAdc, I _B = 0)	V _{(BR)CEO}	-60	_	-	Vdc	
Emitter–Base Breakdown Volt $(I_E = -10 \mu Adc, I_C = 0)$	tage	V _{(BR)EBO}	-5.0	-	-	Vdc
Collector-Base Cutoff Curren (V _{CB} = -50 Vdc, I _E = 0)	t	I _{CBO}	-	-	-10	nAdc
Collector-Emitter Cutoff Curre (V _{CE} = -30 Vdc, V _{BE} = 0.5		I _{CEX}	-	-	-50	nAdc
Base–Emitter Cutoff Current $(V_{CE} = -30 \text{ Vdc}, V_{BE} = -0.$	5 Vdc)	I _{BEX}	-	-	-50	nAdc
ON CHARACTERISTICS	(Note 2)			I	I	· I
DC Current Gain $ \begin{aligned} &(I_C = -0.1 \text{ mAdc, } V_{CE} = -10 \\ &(I_C = -1.0 \text{ mAdc, } V_{CE} = -10 \\ &(I_C = -10 \text{ mAdc, } V_{CE} = -10 \\ &(I_C = -150 \text{ mAdc, } V_{CE} = -10 \\ &(I_C = -500 \text{ mAdc, } V_{CE} = -10 \\ \end{aligned} $	0 Vdc) Vdc) 0 Vdc)	h _{FE}	75 100 100 100 50	- - - -	- - 300 -	-
Collector-Emitter Saturation Voltages ($I_C = -150 \text{ mAdc}$, $I_B = -15 \text{ mAdc}$) ($I_C = -500 \text{ mAdc}$, $I_B = -50 \text{ mAdc}$)		V _{CE(sat)}		- -	-0.4 -1.6	Vdc
Base-Emitter Saturation Volta $(I_C = -150 \text{ mAdc}, I_B = -15 \text{ r} \\ (I_C = -500 \text{ mAdc}, I_B = -50 \text{ mAdc})$	V _{BE(sat)}		_ _	-1.3 -2.6	Vdc	
DYNAMIC CHARACTERIS	STICS				1	- 1
Current-Gain – Bandwidth Pro (I _C = -50 mAdc, V _{CE} = -20		f _T	200	_	-	MHz
Output Capacitance (V _{CB} = -10 Vdc, I _E = 0, f =	C _c	-	-	8.0	pF	
Input Capacitance (V _{EB} = -2.0 Vdc, I _C = 0, f =	C _e	_	-	30	pF	
SWITCHING TIMES						ı
Turn-On Time		t _{on}	-	-	45	ns
Delay Time	$(V_{CC} = -30 \text{ Vdc}, I_{C} = -150 \text{ mAdc}, I_{B_1} = -15 \text{ mAdc})$	t _d	-	-	10	
Rise Time	,	t _r	-		40	
Turn-Off Time		t _{off}	-	-	100	ns
Storage Time	$(V_{CC} = -6.0 \text{ Vdc}, I_C = -150 \text{ mAdc}, I_{B1} = I_{B2} = -15 \text{ mAdc})$	t _s	-	-	80	
Fall Time	t _f	ı	-	30		

^{2.} Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2.0%.

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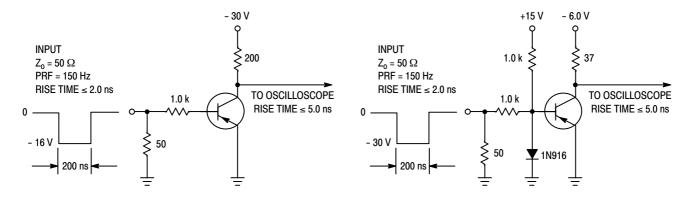


Figure 1. Delay and Rise **Time Test Circuit**

Figure 2. Storage and Fall **Time Test Circuit**

TYPICAL ELECTRICAL CHARACTERISTICS

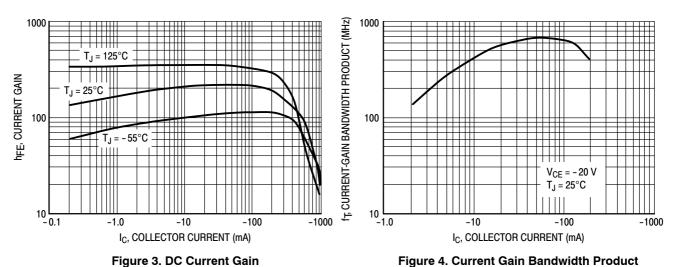


Figure 3. DC Current Gain

-1.0

 $T_J = 25^{\circ}C$

30 20 10 7.0 \mathbf{C}_{cb} 5.0 3.0 -0.2 -0.3 -0.5 -0.7 -1.0 -2.0 -3.0 -5.0 -7.0 -10 -20 -30 REVERSE VOLTAGE (VOLTS)

 $V_{BE(sat)} @ I_C/I_B = 10$ -0.8 VOLTAGE (VOLTS) V_{BE(on)} @ V_{CE} = -10 V -0.2 $V_{CE(sat)} @ I_C/I_B = 10$ -0.1 -0.2 -0.5 -1.0 -2.0 -5.0 -10 -20 -50 -100 -200 -500 IC, COLLECTOR CURRENT (mA)

Figure 5. "ON" Voltage

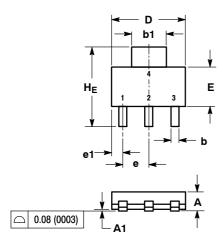
Figure 6. Capacitances

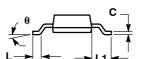
CAPACITANCE (pF)

PZT2907AT1, SPZT2907AT1G

PACKAGE DIMENSIONS

SOT-223 (TO-261) CASE 318E-04 **ISSUE N**





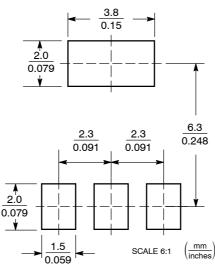
- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- CONTROLLING DIMENSION: INCH.

	MILLIMETERS			INCHES			
DIM	MIN	NOM	MAX	MIN	NOM	MAX	
Α	1.50	1.63	1.75	0.060	0.064	0.068	
A1	0.02	0.06	0.10	0.001	0.002	0.004	
b	0.60	0.75	0.89	0.024	0.030	0.035	
b1	2.90	3.06	3.20	0.115	0.121	0.126	
С	0.24	0.29	0.35	0.009	0.012	0.014	
D	6.30	6.50	6.70	0.249	0.256	0.263	
E	3.30	3.50	3.70	0.130	0.138	0.145	
е	2.20	2.30	2.40	0.087	0.091	0.094	
e1	0.85	0.94	1.05	0.033	0.037	0.041	
L	0.20			0.008			
L1	1.50	1.75	2.00	0.060	0.069	0.078	
HE	6.70	7.00	7.30	0.264	0.276	0.287	
θ	0°	-	10°	0°	-	10°	

- STYLE 1: PIN 1. BASE
 - 2. COLLECTOR 3. EMITTER

 - 4 COLLECTOR

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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